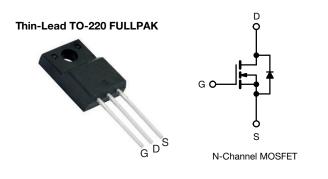
SiHA24N65EF

Vishay Siliconix

E Series Power MOSFET with Fast Body Diode



www.vishay.com

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	700			
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.156		
Q _g max. (nC)	122			
Q _{gs} (nC)	17			
Q _{gd} (nC)	36			
Configuration	Single			

FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Low switching losses due to reduced Q_{rr}
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Consumer and computing
 - ATX power supplies
- Industrial
 - Welding - Battery chargers
- Renewable energy
 - Solar (PV inverters)
- Switch mode power supplies (SMPS)
- · Applications using the following topologies
 - LCC
 - Phase shifted bridge (ZVS)
 - 3-level inverter
 - AC/DC bridge

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free	SiHA24N65EF-E3			
Lead (Pb)-free and halogen-free	SiHA24N65EF-GE3			

SYMBOL V _{DS}	LIMIT	UNIT	
V _{DS}		UNIT	
	650	Ň	
V _{GS}	± 30	- V	
;	10		
	6	А	
I _{DM}	65		
	0.31	W/°C	
E _{AS}	691	mJ	
PD	39	W	
T _J , T _{stg}	-55 to +150	°C	
-I) (/ -I+	70	1//	
av/at	50	V/ns	
	300	°C	
	0.6	Nm	
	C I _D I _D E _{AS} P _D	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_q = 25 \Omega$, $I_{AS} = 7$ A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, dl/dt = 900 A/µs, starting T_J = 25 °C

e. Limited by maximum junction temperature

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COMPLIANT

HALOGEN FREE



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THERMAL RESISTANCE RAT	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	- 65			0000			
Maximum junction-to-case (drain)	R _{thJC}	- 3.2				°C/W		
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	unless otherwi	se noted)						
PARAMETER	SYMBOL		T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static							1	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μA	650	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		e to 25 °C,		-	0.68	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}		- V _{GS} , I _D = 2		2	-	4	V
			$V_{GS} = \pm 20$		-	-	± 100	nA
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30$		-	-	± 1	μA
			520 V, V _G		-	-	1	
Zero gate voltage drain current	IDSS		- -	′, T _J = 125 °C	-	-	500	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V		₀ = 12 A	-	0.13	0.156	Ω
Forward transconductance	9 _{fs}	V _{DS}	= 30 V, I _D =	= 12 A	-	7.2	-	S
Dynamic	•	•				•		1
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	2774	-	pF	
Output capacitance	C _{oss}			-	128	-		
Reverse transfer capacitance	C _{rss}			-	4	-		
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 520 V, V_{GS} = 0 V		-	96	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	333	-		
Total gate charge	Qg				-	81	122	1
Gate-source charge	Q _{gs}	V _{GS} = 10 V I _D = 12 A, V _{DS} = 520 V		-	17	-	nC	
Gate-drain charge	Q _{gd}	1			-	36	-	1
Turn-on delay time	t _{d(on)}		•		-	24	48	
Rise time	t _r	V _{DD} =	$\label{eq:VDD} \begin{array}{l} V_{DD} = 520 \; V, I_D = 12 \; A, \\ V_{GS} = 10 \; V, R_g = 9.1 \; \Omega \end{array}$		-	34	68	ns
Turn-off delay time	t _{d(off)}				-	80	120	
Fall time	t _f			-	46	92	1 '	
Gate input resistance	R _g	f = 1 MHz, open drain		0.2	0.5	1.0	Ω	
Drain-Source Body Diode Characteristi	cs							
Continuous source-drain diode current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	24		
Pulsed diode forward current	I _{SM}			-	-	65	A	
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 12 A, V _{GS} = 0 V		-	0.9	1.2	V	
Reverse recovery time	t _{rr}	, , , , , , , , , , , , , , , , , , ,			-	151	288	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 12 \text{ A},$ dl/dt = 100 A/ μ s, V _R = 400 V		-	0.9	2.1	μC	
Reverse recovery current	I _{RRM}			-	13	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

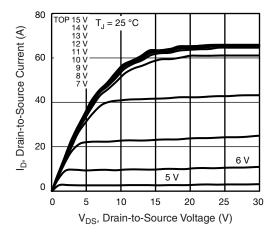


Fig. 1 - Typical Output Characteristics

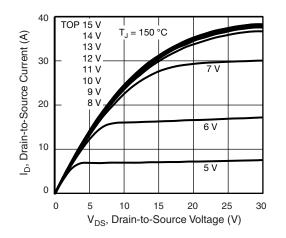


Fig. 2 - Typical Output Characteristics

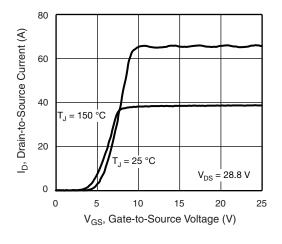


Fig. 3 - Typical Transfer Characteristics

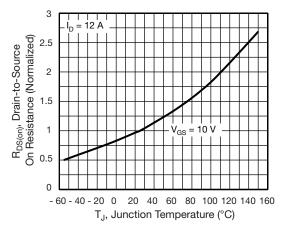


Fig. 4 - Normalized On-Resistance vs. Temperature

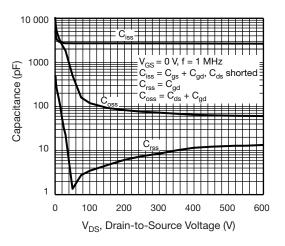


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

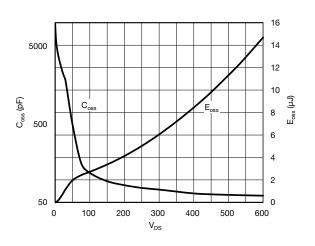


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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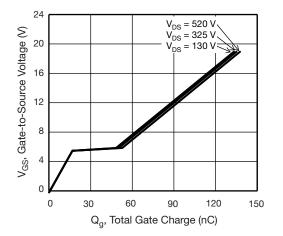


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

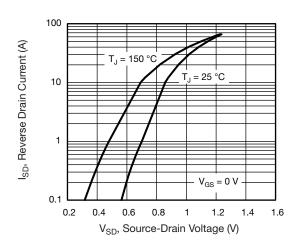
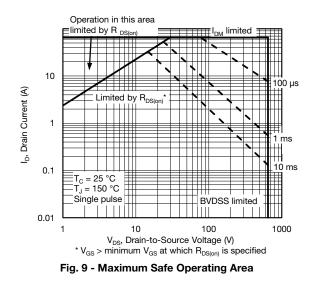


Fig. 8 - Typical Source-Drain Diode Forward Voltage



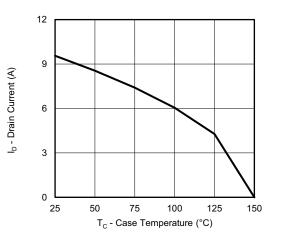
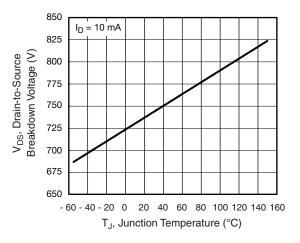


Fig. 10 - Maximum Drain Current vs. Case Temperature





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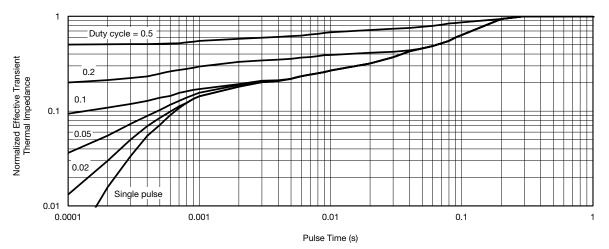
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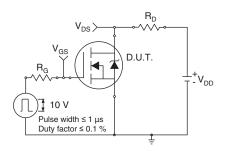


Fig. 13 - Switching Time Test Circuit

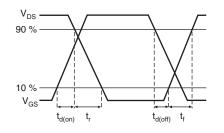


Fig. 14 - Switching Time Waveforms

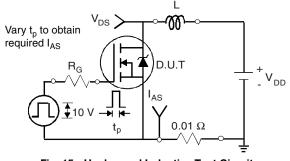
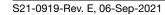


Fig. 15 - Unclamped Inductive Test Circuit



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Fig. 16 - Unclamped Inductive Waveforms

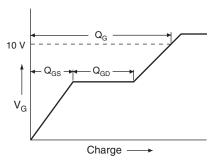
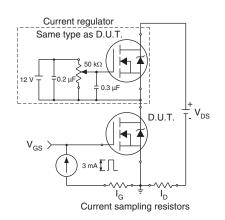


Fig. 17 - Basic Gate Charge Waveform

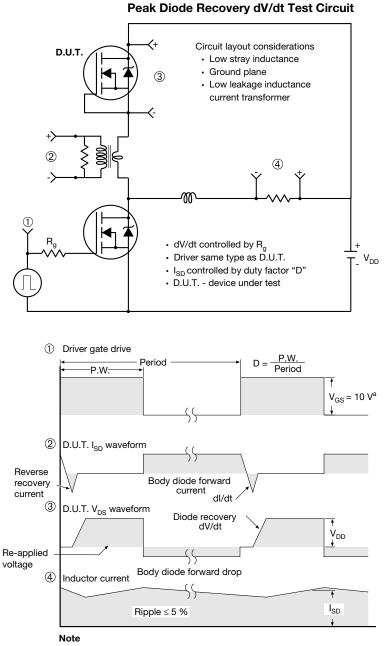


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Fig. 18 - Gate Charge Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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reliability data, see www.vishay.com/ppg?91825.

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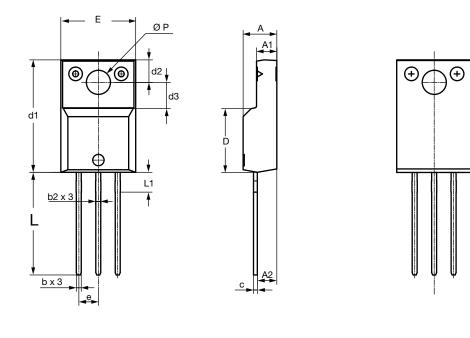
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TO-220 FULLPAK Thin Lead





	DIMENSIONS					
SYMBOL	MILLIN	METERS	INCHES			
	MIN.	MAX.	MIN.	MAX.		
А	4.30	4.70	0.169	0.185		
A1	2.50	2.90	0.098	0.114		
A2	2.40	2.80	0.094	0.110		
b	0.60	0.80	0.024	0.031		
b2	0.60	0.90	0.024	0.035		
С	-	0.60	-	0.024		
D	8.30	8.70	0.327	0.342		
d1	14.70	15.30	0.579	0.602		
d2	2.90	3.10	0.114	0.122		
d3	3.30	3.70	0.130	0.146		
E	9.70	10.30	0.382	0.406		
е	2.50	2.70	0.098	0.106		
L	13.40	13.80	0.528	0.543		
L1	1.00	2.80	0.039	0.110		
ØP	3.00	3.40	0.118	0.134		
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·			

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